# NZD5V1MUT5G Series

# **Zener Voltage Regulators**

# 200 mW Micro Packaged

This Zener diode is designed to provide voltage regulation protection and is especially attractive in situations where space is at a premium. Because of its small size, it is suited for use in mobile applications.

## **Specification Features:**

- Standard Zener Breakdown Voltages: 2.4 V, 2.7 V, 4.7 V, 5.1 V, 5.6 V, 6.2 V
- Steady State Power Rating of 200 mW
- Small Body Outline Dimensions: 0.60 mm x 0.30 mm
- Low Body Height: 0.30 mm
- ESD Rating of Class 3 (>16 kV) per Human Body Model
- These are Pb–Free Devices

Mechanical Characteristics: MOUNTING POSITION: Any QUALIFIED MAX REFLOW TEMPERATURE: 260°C Device Meets MSL 1 Requirements

### MAXIMUM RATINGS

Rating	Symbol	Max	Unit	
IEC 61000–4–2 (ESD) Contact Air		±20 ±20	kV	
Total Device Dissipation FR–5 Board, (Note 1) @ $T_A = 25^{\circ}C$	PD	300	mW	
Thermal Resistance from Junction-to-Ambient	$R_{\thetaJA}$	400	°C/W	
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C	
Lead Solder Temperature – Maximum (10 Second Duration)	ΤL	260	°C	

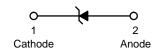
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-5 = 1.0 x 0.75 x 0.62 in.



# **ON Semiconductor®**

http://onsemi.com





X = Specific Device Code M = Month Code

### **ORDERING INFORMATION**

Device	Package	Shipping†
NZDxxxMUT5G	X3DFN (Pb–Free)	15000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

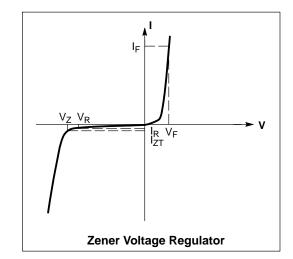
### **DEVICE MARKING INFORMATION**

See specific marking information in the device marking column of the Electrical Characteristics tables starting on page 2 of this data sheet.

### **ELECTRICAL CHARACTERISTICS**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted}, V_F = 1.1 V Max. @ I_F = 10 mA for all types)$ 

Symbol	Parameter
VZ	Reverse Zener Voltage @ I <sub>ZT</sub>
I <sub>ZT</sub>	Reverse Current
Z <sub>ZT</sub>	Maximum Zener Impedance @ I <sub>ZT</sub>
I <sub>ZK</sub>	Reverse Current
Z <sub>ZK</sub>	Maximum Zener Impedance @ I <sub>ZK</sub>
I <sub>R</sub>	Reverse Leakage Current @ V <sub>R</sub>
V <sub>R</sub>	Reverse Voltage
١ <sub>F</sub>	Forward Current
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>
$\Theta V_Z$	Maximum Temperature Coefficient of VZ
С	Max. Capacitance $@V_R = 0$ and f = 1 MHz



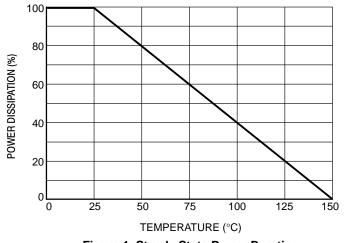


Figure 1. Steady State Power Derating

		Zener Voltage (Note 1) Zener II		r Imped	ance	Leakage	Current			с		
	Device	V <sub>Z</sub> (Volts) @ I <sub>ZT</sub> Z <sub>ZT</sub> @ I <sub>ZT</sub> Z <sub>ZK</sub> @ I <sub>ZK</sub>		I <sub>R</sub> @ V <sub>R</sub>		ΘVz (mV/k) @ I <sub>ZT</sub>		@ V <sub>R</sub> = 0 f = 1 MHz				
Device	Marking	Min	Max	mA	Ω	Ω	mA	μΑ	Volts	Min	Max	pF
NZD2V4MUT5G	A*	2.28	2.52	5	100	1000	1	50	1	-3.5	0	210
NZD2V7MUT5G	D*	2.57	2.84	5	100	1000	1	20	1	-3.5	0	210
NZD4V7MUT5G	Р	4.47	4.94	5	100	800	0.5	2	1	-3.5	0.2	150
NZD5V1MUT5G	Q	4.85	5.36	5	80	500	0.5	2	1.5	-2.7	1.2	130
NZD5V6MUT5G	R	5.32	5.88	5	60	200	0.5	1	2.5	-2.0	2.5	115
NZD6V2MUT5G	Т	5.89	6.51	5	60	100	0.5	1	3.0	0.4	3.7	110

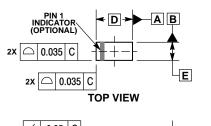
\*Rotated 90°.

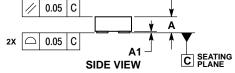
1. Zener voltage is measured with a pulse test current  $I_Z$  at an ambient temperature of 25°C.

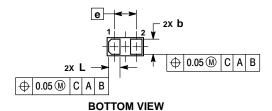
## NZD5V1MUT5G Series

#### PACKAGE DIMENSIONS

#### X3DFN2, 0.62x0.32, 0.355P, (0201) CASE 152AF ISSUE O



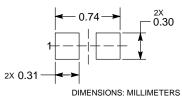




- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS.

	-	-				
	MILLIMETERS					
DIM	MIN MAX					
Α	0.25	0.33				
A1		0.05				
b	0.22	0.28				
D	0.62 BSC					
E	0.32 BSC					
е	0.355 BSC					
1	0.17	0.23				

#### RECOMMENDED MOUNTING FOOTPRINT\*



See Application Note AND8398/D for more mounting details

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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